

101592967

APPLICATION DATA SHEET**Application Information**

Application number::

Filing Date::

Application Type::

Regular

Subject Matter::

Utility

Suggested classification::

Suggested Group Art Unit::

CD-ROM or CD-R?::

None

Number of CD disks::

Number of copies of CDs::

Sequence submission?::

Computer Readable Form (CRF)?::

No

Number of copies of CRF::

Title ::

DIELECTRIC PASTE FOR A MULTI-LAYERED
CERAMIC ELECTRONIC COMPONENT AND A
METHOD FOR MANUFACTURING A MULTI-
LAYERED UNIT FOR A MULTI-LAYERED
CERAMIC ELECTRONIC COMPONENT

Attorney Docket Number::

890050.547USPC

Request for Early Publication?::

No

Request for Non-Publication?::

No

Suggested Drawing Figure::

Total Drawing Sheets::

Small Entity?::

No

Petition included?::

No

Petition Type::

Licensed U.S. Gov't Agency::

Contract or Grant No::

Secrecy Order in Parent Appl.?:: No

First Applicant Information

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Shigeki
Middle Name::
Family Name:: Satou
Name Suffix::
City of Residence:: Tokyo
State or Province of Residence::
Country of Residence:: Japan
Street of mailing address:: c/o TDK Corporation, 1-13-1,
Nihonbashi, Chuo-ku
City of mailing address:: Tokyo
State or Province of mailing address::
Country of mailing address:: Japan
Postal or Zip Code of mailing address:: 103-8272

Second Applicant Information

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Takeshi
Middle Name::
Family Name:: Nomura
Name Suffix::
City of Residence:: Tokyo

State or Province of Residence::

Country of Residence:: Japan

Street of mailing address:: c/o TDK Corporation, 1-13-1,
Nihonbashi, Chuo-ku

City of mailing address:: Tokyo

State or Province of mailing address::

Country of mailing address:: Japan

Postal or Zip Code of mailing address:: 103-8272

Correspondence Information

Correspondence Customer Number :: **00500**

Representative Information

Representative Customer Number::		00500
----------------------------------	--	--------------

Domestic Priority Information

Application ::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application	National Stage of	PCT/JP2005/004607	03/16/05

Foreign Priority Information

Country::	Application number::	Filing Date::	Priority Claimed::
Japan	2004-073664	03/16/04	Yes

Assignee Information

Assignee name::	TDK Corporation
Street of mailing address::	1-13-1, Nihonbashi, Chuo-ku
City of mailing address::	Tokyo
State or Province of mailing address::	
Country of mailing address::	Japan
Postal or Zip Code of mailing address::	103-8272

834860_1.DOC